

# **Specification Sheet**

P/N: GMLB-160808-L Series-RU

Products: Certifications:

Molded Power Chokes ISO9001

Multilayer Chip Inductors IATF16949

<u>Lan Transformer</u> ISO14001

RF Passive / Antennas QC080000

**Automotive** 

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## APPLICATION

GMLB chip beads can be used in a variety of electronic applications including:

- Computers and Computer Peripherals
- Cellular Communication Equipment
- Digital Cameras
- Digital Televisions
- Audio Equipment

#### **FEATURES**

The GMLB Series is Mag.Layers' line of high quality ferrite chip beads. Using the latest in multilayer technology, we have developed chip beads that are able to resolve all EMI/EMC issues. High quality, reliability, and versatility make the GMLB series chip beads suitable for all your design needs.

- High Reliability
  - The monolithic inorganic materials used to construct GMLB chips restrain magnetic flux leakage thereby minimizing EMI concerns. GMLB chips are also extremely effective with unstable grounding.
- Small Chip-Shaped Design
   The chip-shaped design makes GMLB chip beads ideal for automatic mounting.
- High Soldering Heat Resistance
   High quality termination allows both flow and re-flow soldering methods to be
   applied.
- Sharp High Frequency Characteristics
   The GMLB high frequency chip series has sharp impedance characteristics, which make it suitable for high-speed signal lines.

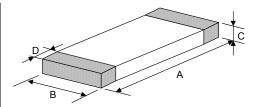
## PRODUCT IDENTIFICATION

| <u>G M L B</u> | - | <u>100505</u> | - | 0030 | <u>A</u>   | <u>N</u> 8 - | RU |
|----------------|---|---------------|---|------|------------|--------------|----|
| (1)            |   | 2             |   | 3    | <b>4</b> ) | (5)          | 6  |

- ① Product Code
- ② Dimension Code
- ③ Impedance (at 100 MHz)
- Series Type
- S Design Code
- © Code for Special Specification



# PRODUCT DIMENSION

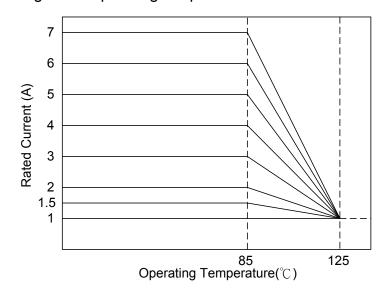


NOTE: Dimensions in mm

| PRODUCT NO. | А             | В             | С             | D              |
|-------------|---------------|---------------|---------------|----------------|
| GMLB-321611 | 3.2±0.20      | 1.6±0.20      | 1.1±0.20      | 0.5±0.30       |
| (1206)-RU   | (0.126±0.008) | (0.063±0.008) | (0.043±0.008) | (0.020±0.012)  |
| GMLB-201209 | 2.0±0.20      | 1.2±0.20      | 0.9±0.20      | 0.5±0.30       |
| (0805)-RU   | (0.079±0.008) | (0.047±0.008) | (0.035±0.008) | (0.020±0.012)  |
| GMLB-160808 | 1.6±0.15      | 0.8±0.15      | 0.8±0.15      | 0.3±0.20       |
| (0603)-RU   | (0.063±0.006) | (0.031±0.006) | (0.031±0.006) | (0.012±0.008)  |
| GMLB-100505 | 1.0±0.10      | 0.5±0.10      | 0.5±0.10      | 0.25±0.10      |
| (0402)-RU   | (0.039±0.004) | (0.019±0.004) | (0.019±0.004) | (0.0095±0.004) |

# CURRENT DERATING

In operating temperatures exceeding  $+85^{\circ}$ C, derating of current is necessary for chip ferrite beads for which rated current is 1.5A or over. Please apply the derating curve shown below according to the operating temperature.





#### **ELECTRICAL REQUIREMENTS**

| Part Number             | Impedance (Ω) at 100 MHz | $R_{DC}(\Omega)$ Max. | I <sub>DC</sub> (mA) Max. | Operating<br>Temp. Range (℃) |
|-------------------------|--------------------------|-----------------------|---------------------------|------------------------------|
| GMLB-160808-0030L-N8-RU | 30±25%                   | 0.05                  | 750                       |                              |
| GMLB-160808-0060L-N8-RU | 60±25%                   | 0.1                   | 650                       |                              |
| GMLB-160808-0120L-N8-RU | 120±25%                  | 0.15                  | 550                       |                              |
| GMLB-160808-0150L-N8-RU | 150±25%                  | 0.15                  | 500                       | -55 ~ +125                   |
| GMLB-160808-0220L-N8-RU | 220±25%                  | 0.2                   | 550                       | -55 * 1125                   |
| GMLB-160808-0300L-N8-RU | 300±25%                  | 0.25                  | 500                       |                              |
| GMLB-160808-0470L-N8-RU | 470±25%                  | 0.3                   | 450                       |                              |
| GMLB-160808-0600L-N8-RU | 600±25%                  | 0.35                  | 350                       |                              |

Temperature rise should be less than 40<sup>°</sup>C for P-type and less than 25<sup>°</sup>C for other types when rated current is applied.

#### MEASURING METHOD / CONDITION

Test Instrument:

Z: Agilent 4291B Impedance Analyzer, Test Fixture: Agilent 16192

Osc. Level: 500mV

R<sub>DC</sub>: Agilent 34401A

Test Condition:

< Unless otherwise specified >

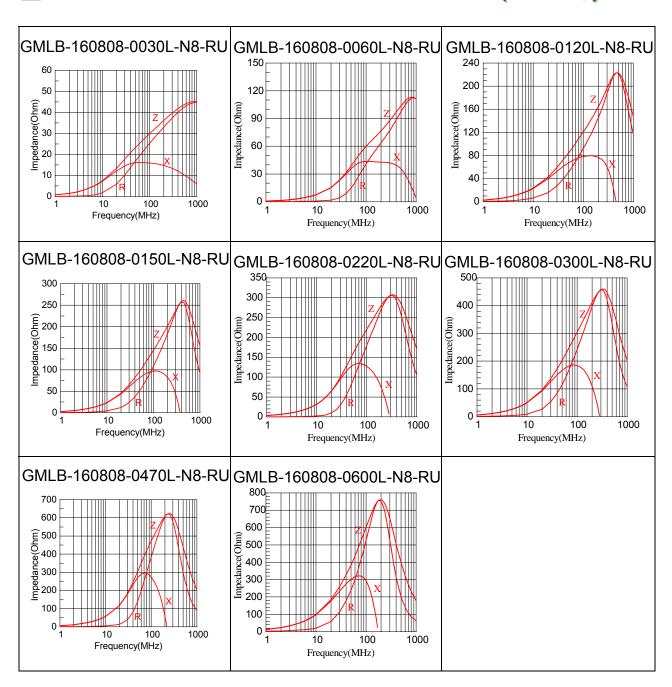
Temperature: 15°C to 35°C Humidity: 25% to 85% RH

< In case of doubt >

Temperature: 25°C ± 2°C Humidity: 60% to 70% RH



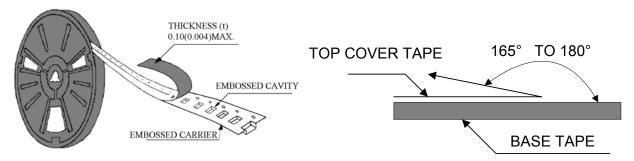
# TYPICAL ELECTRICAL CHARACTERISTICS (T=25%)





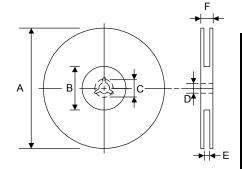
# PACKAGING

#### Peel-off Force

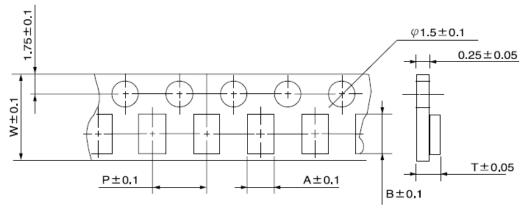


The force for peeling off cover tape is 10 grams in the arrow direction.

#### Dimension (Unit: mm)



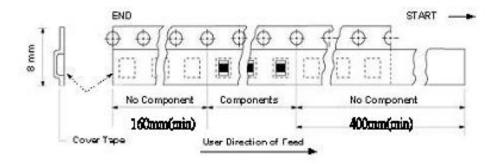
| TYPE  | Α       | В             | С         | D         | E         | F       |
|-------|---------|---------------|-----------|-----------|-----------|---------|
| 8 mm  | 178±1   | 60 +0.5<br>-0 | -         | 13 ±0.2   | 9 ±0.5    | 12 ±0.5 |
| 12 mm | 178±0.3 | 60 ±0.2       | 19.3 ±0.1 | 13.5 ±0.1 | 13.6 ±0.1 | -       |



| TYPE | SIZE   | Α   | В   | W | Р |      | T          | CHIPS/REEL |
|------|--------|-----|-----|---|---|------|------------|------------|
|      | 100505 | 0.6 | 1.1 | 8 | 2 |      | 1.0        | 10000      |
| CMLD | 160808 | 1.1 | 1.9 | 8 | 4 | 1.1, | *0.95±0.05 | 4000       |
| GMLB | 201209 | 1.5 | 2.3 | 8 | 4 | 1.3, | *0.95±0.10 | 4000       |
|      | 321611 | 1.9 | 3.5 | 8 | 4 |      | 1.5        | 3000       |

<sup>\*:</sup> For paper reels

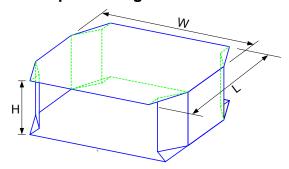




## Taping Quantity

| SERIES   | 3216 | 2012 | 1608 | 1005  |
|----------|------|------|------|-------|
| PCS/Reel | 3000 | 4000 | 4000 | 10000 |

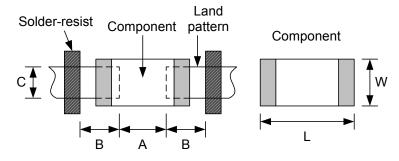
## Tape Packing Case



| No. of<br>Reels | W      | L      | Н       |
|-----------------|--------|--------|---------|
| 2               | 18±0.5 | 18±0.5 | 2.4±0.2 |
| 3               | 18±0.5 | 18±0.5 | 3.6±0.2 |
| 4               | 18±0.5 | 18±0.5 | 4.8±0.2 |
| 5               | 18±0.5 | 18±0.5 | 6.0±0.2 |

Unit: cm

# RECOMMENDED PCB LAYOUT



Unit: mm

| Тур  | е | 1005      | 1608    | 2012    | 3216    |
|------|---|-----------|---------|---------|---------|
| 0:   | L | 1.0       | 1.6     | 2.0     | 3.2     |
| Size | W | 0.5       | 0.8     | 1.2     | 1.6     |
| А    |   | 0.45~0.55 | 0.6~0.8 | 0.8~1.2 | 1.8~2.2 |
| В    |   | 0.40~0.50 | 0.6~0.8 | 0.8~1.2 | 1.1~1.6 |
| С    |   | 0.40~0.50 | 0.6~0.8 | 0.9~1.6 | 0.9~1.6 |



# RELIABILTY TEST

| Mechanical Perfo          |  |  |   |   |
|---------------------------|--|--|---|---|
| ITEM                      | SPECIFICATION  | TEST   | CONDITIC                                      | N   |
| Solderability             | More than 90% of the terminal electrode shall be covered with fresh solder.                      | all Solder: 96.5Sn-3.0Ag-0.5Cu Solder Temperature: $245 \pm 5^{\circ}$ C Flux: Rosin Dip Time: $3 \pm 1$ Seconds           |   | ;   |
| Soldering Heat Resistance | The chip shall not crack.  More than 75% of the terminal electrode shall be covered with solder. | Solder: 96.5Sn-3.0<br>Solder temperature<br>Flux: Rosin<br>Dip time: 10 ± 1 se   | e: 260 ± 5°C                                  |   |
|                           | The terminal electrode shall not be broken off nor the ferrite damaged.                          | TYPE   | W(KGF)  | TIME (SEC)                                    |
|                           | nor the lettle damaged.  | GMLB-160808  | 0.6   |   |
| Terminal Strength         | w  | GMLB-201209  | 0.6   | 20 ± 5  |
|                           | <b>→</b>   | GMLB-321611  | 1.0   | 30 ± 5  |
|                           |  | GMLB-453215  | 1.5   |   |
|                           | The terminal electrode shall not be broken off nor the ferrite damaged.                          | TYPE   | W(KGF)  | TIME (SEC)                                    |
|                           |  | GMLB-160808  | 1.0   |   |
| Terminal Strength         |  | GMLB-201209  | 1.0   | 10 ± 5  |
|                           |  | GMLB-321611  | 2.0   |   |
|                           |  | GMLB-453215  | 2.0   |   |
|                           | No mechanical damage.  | TYPE   | A(MM)   | P(KGF)  |
|                           | The ferrite shall not be damaged.  R0.5 → 1.0 Chin   | GMLB-160808  | 1.0   | 1.0   |
| Bending Strength          | P Chip   | GMLB-201209  | 1.4   | 1.0   |
|                           |  | GMLB-321611  | 2.0   | 2.0   |
|                           | A △ →  | GMLB-453215  | 2.7   | 2.5   |
| Bending Test              | Appearance: No damage Pressure jig  Deflection  45  Product (in mm)                              | Substrate: PCB(1<br>Solder: Reflow<br>Speed of Applying<br>Deflection: 2mm<br>Hold Duration: 30                            | g Force: 0.5<br>s                             | 5mm / s                                       |
| Vibration                 | Impedance shall be within $\pm$ 20% of the initial value. There shall be no mechanical damage.   | The sample sha<br>printed circuit boo<br>having an ampli<br>frequency of fror<br>repeated should be<br>(X,Y,Z) for 2 hours | ard and whatude of 1.  m 10 to 5 e applied to | en a vibration<br>52mm and a<br>55Hz/1 minute |
| Drop shock                | No apparent damage   | Dropped onto position of the terminals shall   | e times in x,                                 | y, z directions.                              |



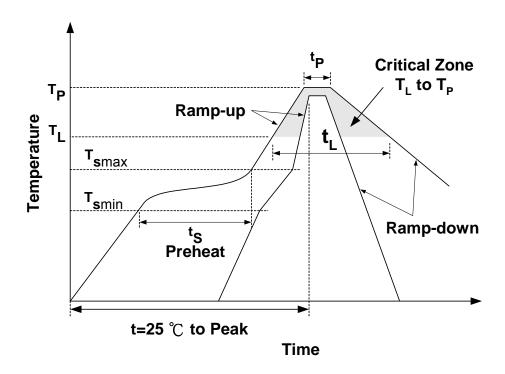
| <ul> <li>Climatic test</li> </ul> |  |   |
|-----------------------------------|--|---|
| ITEM                              | SPECIFICATION                                      | TEST CONDITION                          |
| Thermal Shock                     | Impedance shall be within $\pm$ 20% of the initial | Temperature: -55°C~125°C for 30 minutes |
| (Temperature Cycle)               | value.   | each, 100 cycles.                       |
|                                   |  | Temperature : 60°C                      |
| Humidity Resistance               |  | Humidity: 95% RH                        |
|                                   |  | Time: 1000 ± 12 Hours                   |
| High Temperature                  |  | Temperature : 85°C±2°C                  |
| Resistance                        |  | Time: 1000 ± 12 Hours                   |
| Low Temperature                   |  | Temperature : -40°C±2°C                 |
| Resistance                        |  | Time: 1000 ± 12 Hours                   |

<sup>1.</sup> Operating Temperature Range: -55 °C TO +125°C



<sup>2.</sup> Storage Condition: The temperature should be within -40°C∼85°C and humidity should be less than 75% RH. The product should be used within 6 months from the time of delivery.

# RECOMMENDED REFLOW SOLDERING PROFILE



| Profile Feature  |                               | Sn-Pb           | Pb-Free          |
|--|-------------------------------|-----------------|------------------|
|  | t <sub>s</sub>                | 60~120 seconds  | 60~180 seconds   |
| Preheat  | T <sub>smin</sub>             | 100℃            | 150℃             |
|  | T <sub>smax</sub>             | 150℃            | 200℃             |
| Average ramp-up rate (T <sub>smax</sub> to T <sub>P</sub> )    |                               | 3°C/second max. | 3°C/second max.  |
| T'   | Temperature (T <sub>L</sub> ) | 183℃            | <b>217</b> ℃     |
| Time main above  | Time (t <sub>L</sub> )        | 60~150 seconds  | 60~150 seconds   |
| Peak temperature   | $(T_P)$                       | <b>230</b> ℃    | <b>250~260</b> ℃ |
| Time within 5℃ of actual peak<br>temperature (t <sub>P</sub> ) |                               | 10 seconds      | 10 seconds       |
| Ramp-down rate   |                               | 6°C/sec max.    | 6°C/sec max.     |
| Time 25 $℃$ to peak  | k temperature                 | 6 minutes max.  | 8 minutes max.   |

# **NOTES**

The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

